

CEM4936-VB Datasheet Dual N-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|--|--------------------|-----------------------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | Q _g (Typ.) | | | |
| 30 | $0.022 \text{ at V}_{GS} = 10 \text{ V}$ | 6.8 | 15 nC | | | |
| 30 | 0.026 at V _{GS} = 4.5 V | 6.0 | 10110 | | | |

SO-8 S1 1 8 D1 G1 2 7 D1 S2 3 6 D2 G2 4 5 D2

Top View

FEATURES

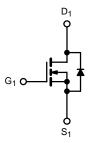
- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % UIS Tested
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

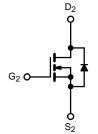


ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Set Top Box
- Low Current DC/DC





N-Channel MOSFET

N-Channel MOSFET

| Parameter | Symbol | Limit | Unit | |
|--|---|-----------------------------------|---|----|
| Drain-Source Voltage | V _{DS} | 30 | V | |
| Gate-Source Voltage | | V _{GS} | ± 20 | V |
| Continuous Drain Current (T _J = 150 °C) | $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$ | I _D | 6.8 ^a 5.6 6.2 ^{b, c} 5.2 ^{b, c} | A |
| Pulsed Drain Current | | I _{DM} | 30 | |
| Continuous Source-Drain Diode Current | $T_C = 25 ^{\circ}C$ $T_A = 25 ^{\circ}C$ | I _S | 2.25 1.48 ^{b, c} | |
| Single Pulse Avalanche Current | L = 0.1 mH | I _{AS} | 5 | |
| Single Pulse Avalanche Energy | | E _{AS} | 1.25 | mJ |
| Maximum Power Dissipation | $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$ | P _D | 2.7 1.77 1.78 ^{b, c} 1.14 ^{b, c} | W |
| Operating Junction and Storage Temperature Range | | T _J , T _{sta} | - 55 to 150 | °C |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|--|
| Parameter | | Symbol | Typical | Maximum | Unit | | |
| Maximum Junction-to-Ambient ^{a, c, d} | t ≤ 10 s | R _{thJA} | 58 | 70 | °C/W | | |
| Maximum Junction-to-Foot (Drain) | Steady State | $R_{th,IF}$ | 38 | 45 | | | |

Notes:

- a. Package limited, T_C = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s
- d. Maximum under Steady State conditions is 110 °C/W.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|-------------------------|--|-------|-------|-------|---------|
| Static | | | • | | | • |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 30 | | | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 250 μA | | 32 | | mV/°C |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | | - 5.0 | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$ | 1.0 | | 2.5 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zara Oata Valla va Daria Oamaal | I _{DSS} | V _{DS} = 30 V, V _{GS} = 0 V | | | 1 | |
| Zero Gate Voltage Drain Current | | V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C | | | 10 | μA |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 10 | | | Α |
| | 5 | $V_{GS} = 10 \text{ V, } I_D = 5 \text{ A}$ | 0.022 | | | + |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 4.5 \text{ V}, I_D = 4 \text{ A}$ | | 0.026 | | Ω |
| Forward Transconductance ^a | g _{fs} | $V_{DS} = 10 \text{ V}, I_D = 5 \text{ A}$ | | 16 | | S |
| Dynamic ^b | <u> </u> | | 1 | | l | l |
| Input Capacitance | C _{iss} | | | 586 | | pF |
| Output Capacitance | C _{oss} | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 117 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 55 | | |
| Total Cata Chausa | Q _g | $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$ | | 15 | | nC |
| Total Gate Charge | | | | 3.7 | 5.6 | |
| Gate-Source Charge | Q_{gs} | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$ | | 1.4 | | |
| Gate-Drain Charge | Q_{gd} | | | 1.05 | | |
| Gate Resistance | R_g | f = 1 MHz | 0.8 | 4.3 | 8.6 | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 12 | 24 | |
| Rise Time | t _r | V_{DD} = 15 V, R_L = 3 Ω | | 55 | 100 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D\cong 5$ A, V_{GEN} = 4.5 V, R_g = 1 Ω | | 11 | 22 | |
| Fall Time | t _f | | | 8 | 16 | |
| Turn-On Delay Time | t _{d(on)} | | | 4 | 8 | ns - |
| Rise Time | t _r | V_{DD} = 15 V, R_L = 3 Ω | | 9 | 18 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D\cong 5$ A, V_{GEN} = 10 V, R_g = 1 Ω | | 10 | 20 | |
| Fall Time | t _f | | | 6 | 12 | |
| Drain-Source Body Diode Characteristic | s | | | | | _ |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | | | 2.25 | ۸ |
| Pulse Diode Forward Current | I _{SM} | | | | 24 | - A |
| Body Diode Voltage | V_{SD} | I _S = 2 A, V _{GS} = 0 V | | 0.8 | 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | 11 | 20 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | L _ E A dl/dt _ 100 A/::2 T _ 25 °C | | 4 | 8 | nC |
| Reverse Recovery Fall Time | ta | $I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$ | | 7 | | |
| Reverse Recovery Rise Time | t _b | | | 4 | | ns |

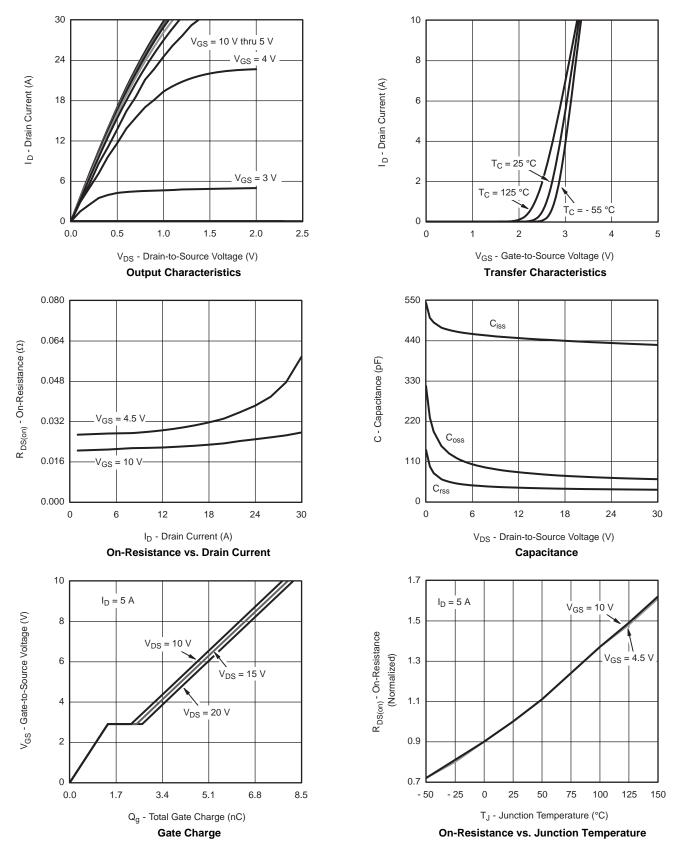
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

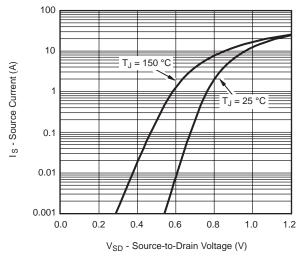
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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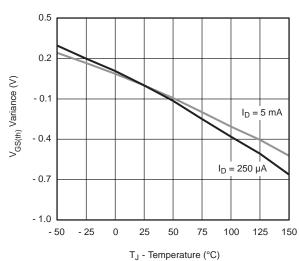




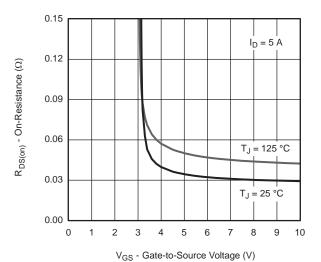




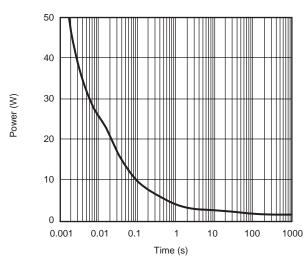
Source-Drain Diode Forward Voltage



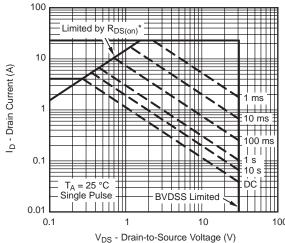
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



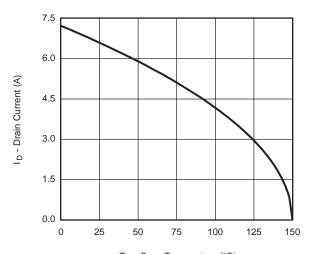
Single Pulse Power



* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

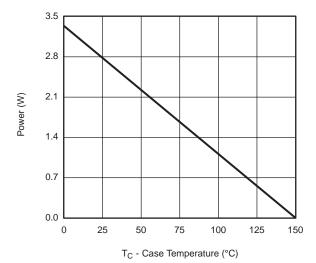
Safe Operating Area, Junction-to-Ambient



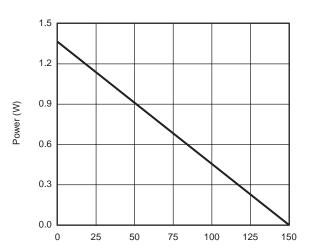


T_C - Case Temperature (°C)

Current Derating*



Power, Junction-to-Foot



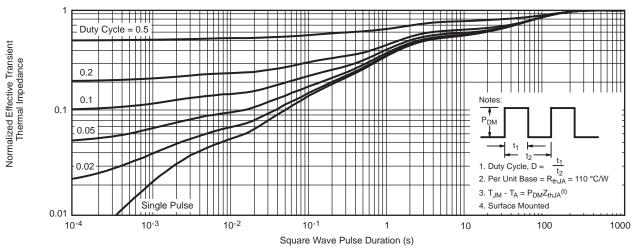
T_A - Ambient Temperature (°C)

Power, Junction-to-Ambient

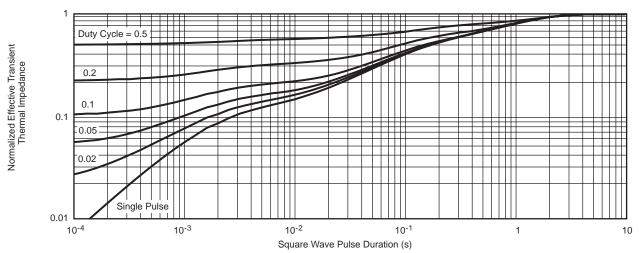
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^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





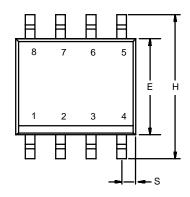
Normalized Thermal Transient Impedance, Junction-to-Ambient

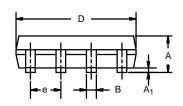


Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEADJEDEC Part Number: MS-012







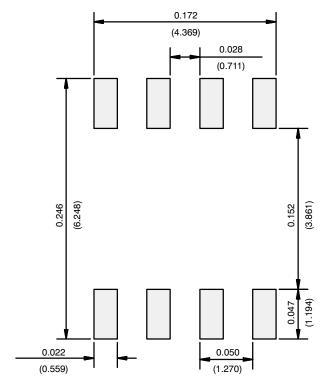
| | MILLIM | IETERS | INC | INCHES | | |
|------------------------------|----------|--------|-----------|--------|--|--|
| DIM | Min | Max | Min | Max | | |
| Α | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 BSC | | 0.050 BSC | | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| FCN: C-06527-Rev I 11-Sen-06 | | | | | | |

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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